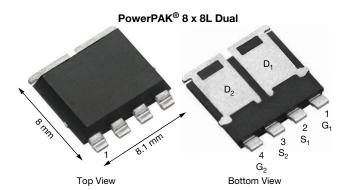
# SQJQ904E

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SHA

**Vishay Siliconix** 

# Automotive Dual N-Channel 40 V (D-S) 175 °C MOSFET



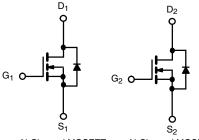
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	40			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 V$	0.0034			
I <sub>D</sub> (A) per leg	100			
Configuration	Dual			
Package	PowerPAK 8 x 8L			

#### FEATURES

- TrenchFET<sup>®</sup> power MOSFET
- AEC-Q101 qualified
- 100 %  $R_q$  and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



RoHS COMPLIANT HALOGEN FREE



N-Channel MOSFET N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	<b>S</b> (T <sub>C</sub> = 25 °C, unles	s otherwise noted	l)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	40	V	
Gate-source voltage		V <sub>GS</sub>	± 20	v	
Continuous drain current	T <sub>C</sub> = 25 °Ca	I-	100		
	T <sub>C</sub> = 125 °C	I <sub>D</sub>	64		
Continuous source current (diode conduction) <sup>a</sup>		I <sub>S</sub>	100	А	
Pulsed drain current <sup>b</sup>		I <sub>DM</sub>	300		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	50		
Single pulse avalanche energy		E <sub>AS</sub>	125	mJ	
Maximum power dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	D-	75	W	
	T <sub>C</sub> = 125 °C	PD	25	vv	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub> -55 to +175		°C	
Soldering recommendations (peak temperature) d, e			260	C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount <sup>c</sup>	R <sub>thJA</sub>	85	°C/W	
inction-to-case (drain)		R <sub>thJC</sub>	2	0/10	

Notes

a. Package limited.

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

c. When mounted on 1" square PCB (FR4 material).

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 8 x 8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = 250 \ \mu A$		40	-	-	v
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		3	3.5	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Zero gate voltage drain current		$V_{GS} = 0 V$	V <sub>DS</sub> = 20 V	-	-	1	μA
	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50	
		$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	150	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	40	-	-	Α
Drain-source on-state resistance <sup>a</sup>		$V_{GS} = 10 \text{ V}$	I <sub>D</sub> = 20 A	-	0.0029	0.0034	Ω
	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	$I_D = 20 \text{ A},  \text{T}_\text{J} = 125 \ ^\circ\text{C}$	-	-	0.0074	
		$V_{GS} = 10 V$	$I_D = 20 \text{ A},  \text{T}_\text{J} = 175 \ ^\circ\text{C}$	-	-	0.0091	
Forward transconductance <sup>b</sup>	<b>g</b> fs	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A		-	80	-	S
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>			-	4530	5900	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	V V <sub>DS</sub> = 20 V, f = 1 MHz	-	2750	3300	pF
Reverse transfer capacitance	C <sub>rss</sub>	]		-	168	220	
Total gate charge <sup>c</sup>	Qg	V <sub>GS</sub> = 10 V	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 40 \text{ A}$	-	60	75	nC
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>			-	16	-	
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	5	-	
Gate resistance	Rg	f = 1 MHz		0.5	1	2	Ω
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>			-	15.5	20	
Rise time <sup>c</sup>	t <sub>r</sub>	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 20 \ \text{V}, \ R_{\text{L}} = 0.5 \ \Omega \\ I_{\text{D}} \cong 40 \ \text{A}, \ V_{\text{GEN}} = 10 \ \text{V}, \ R_{\text{g}} = 1 \ \Omega \end{array}$		-	4.6	6.2	ns
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>			-	30	38	
Fall time <sup>c</sup>	t <sub>f</sub>			-	4	7	
Source-Drain Diode Ratings and Cha	racteristics <sup>b</sup>						
				-	-	200	Α
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	200	A

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

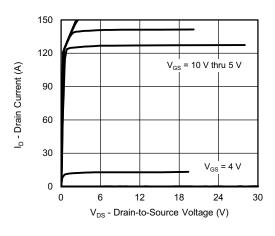
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

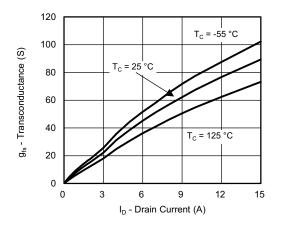


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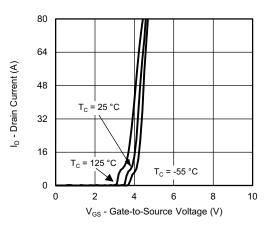
## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



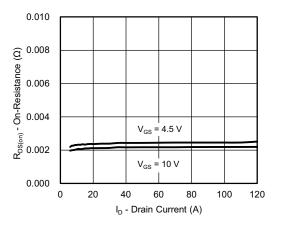
**Output Characteristics** 



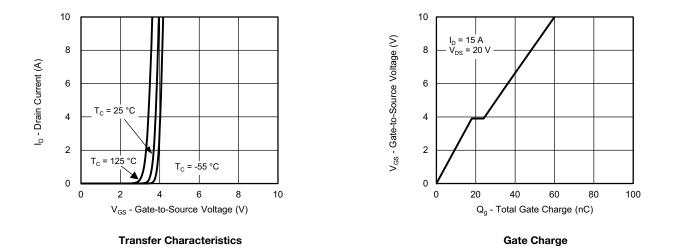
Transconductance



**Transfer Characteristics** 



**On-Resistance vs. Drain Current** 



S17-0256-Rev. A, 20-Feb-17

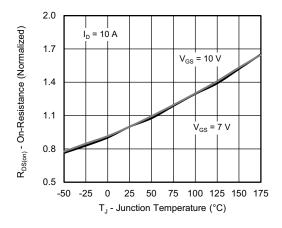
3 s. contact: automostechs Document Number: 68442

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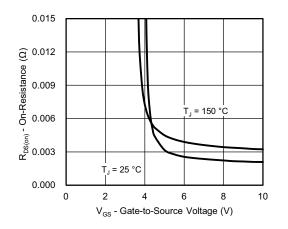


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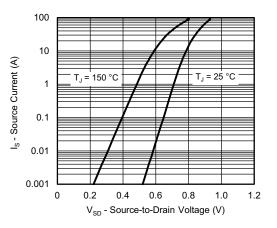
## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



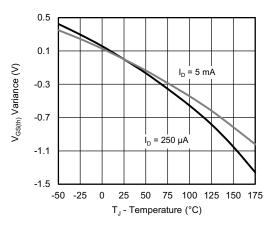
**On-Resistance vs. Junction Temperature** 

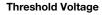


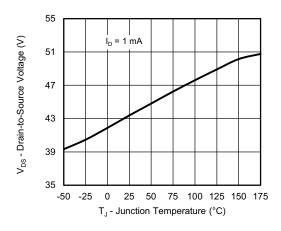
On-Resistance vs. Gate-to-Source Voltage



Source Drain Diode Forward Voltage







Drain Source Breakdown vs. Junction Temperature

4

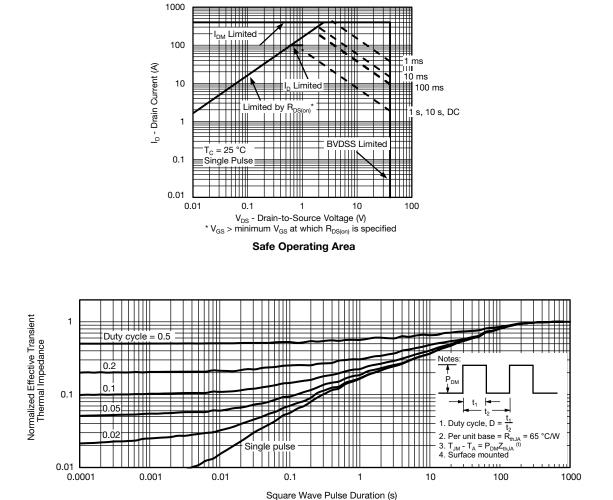
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#### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Square wave Fulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Ambient

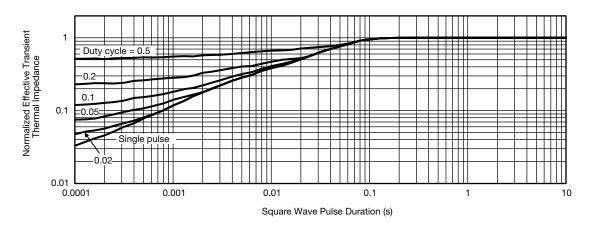


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#### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



#### Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

• The characteristics shown in the two graphs

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- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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